

# **N-Channel Enhancement Mode Power MOSFET**

### **General Description**

The series of Power MOSFETs use advanced technology and design. This high voltage MOSFET fits Switched applications.

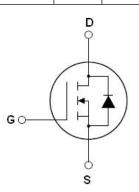
#### **Features**

- High speed switching
- Intrinsic capacitances and Qg minimized
- ●100% Avalanche Tested

#### **Application**

Switched applications

V <sub>DS min@Tjmax</sub>	1850	V
R <sub>DS(ON)TYP</sub>	6	Ω
ID	2.9	Α
Qg	33	nC



Schematic diagram

#### **Package Marking And Ordering Information**

Device	Device Package	Marking
NCE3N170T	TO-247	NCE3N170T



TO-247

Table 1. Absolute Maximum Ratings (T<sub>c</sub>=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (VGS=0V)	V <sub>DS</sub>	1700	V
Gate-Source Voltage (VDS=0V) DC	Vgs	±30	V
Continuous Drain Current at Tc=25°C	I <sub>D (DC)</sub>	2.9	Α
Continuous Drain Current at Tc=100°C	I <sub>D (DC)</sub>	2.03	Α
Pulsed drain current (Note 1)	I <sub>DM (pluse)</sub>	8.7	Α
Maximum Power Dissipation(Tc=25°C)	P <sub>D</sub>	187	W
Derate above 25°C		1.24	W/°C
Single pulse avalanche energy (Note 2)	Eas	210	mJ
Single pulse avalanche current (Note 2)	I <sub>AS</sub>	2.9	Α
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55+175	°C

<sup>\*</sup> limited by maximum junction temperature



#### **Table 2. Thermal Characteristic**

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R <sub>thJC</sub>	0.8	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R <sub>thJA</sub>	50	°C /W

Table 3. Electrical Characteristics (TA=25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =1mA	1700			V
Zero Gate Voltage Drain Current(Tc=25℃)	I <sub>DSS</sub>	V <sub>DS</sub> =1700V,V <sub>GS</sub> =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125°ℂ)	I <sub>DSS</sub>	V <sub>DS</sub> =1700V,V <sub>GS</sub> =0V			100	μA
Gate-Body Leakage Current	Igss	V <sub>GS</sub> =±30V,V <sub>DS</sub> =0V			±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	3	4	5	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =1.45A		6	8	Ω
Dynamic Characteristics						
Input Capacitance	C <sub>lss</sub>	10111		1700		pF
Output Capacitance	Coss	V <sub>DS</sub> =40V,V <sub>GS</sub> =0V,		60		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz		3.3		pF
Total Gate Charge	Qg	\/ 4050\/ L 4.45A		33		nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =1350V,I <sub>D</sub> =1.45A, V <sub>GS</sub> =10V f = 1 MHz open drain		7.7		nC
Gate-Drain Charge	$Q_{gd}$			14		nC
Intrinsic gate resistance	R <sub>G</sub>			2		Ω
Switching times						
Turn-on Delay Time	t <sub>d(on)</sub>			22		nS
Turn-on Rise Time	t <sub>r</sub>	V <sub>DD</sub> =850V,I <sub>D</sub> =1.45A,		8		nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_G=3\Omega,V_{GS}=10V$		48		nS
Turn-Off Fall Time	t <sub>f</sub>			49		nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I <sub>SD</sub>	T 05%0			2.9	Α
Pulsed Source-drain current(Body Diode)	I <sub>SDM</sub>	T <sub>C</sub> =25°C			8.7	Α
Forward On Voltage	V <sub>SD</sub>	Tj=25°C,I <sub>SD</sub> =2.9A,V <sub>GS</sub> =0V		0.8	1.1	V
Reverse Recovery Time	t <sub>rr</sub>	T:-05°C   0.04		1500		nS
Reverse Recovery Charge	Qrr	Tj=25°C,I⊧=2.9A, di/dt=100A/μs		5.6		uC
Peak Reverse Recovery Current	I <sub>rrm</sub>	ai/αι–τυυΑ/μs		7.5		Α

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25 $^{\circ}$ C,VDD=50V,VG=10V, R<sub>G</sub>=25 $\Omega$ 



#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

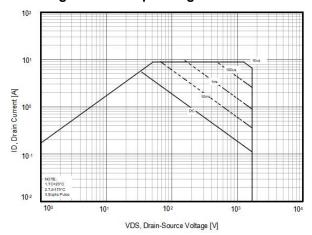


Figure 2. Source-Drain Diode Forward Voltage

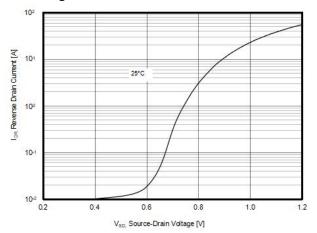


Figure 3. R<sub>DS(ON)</sub> vs Junction Temperature

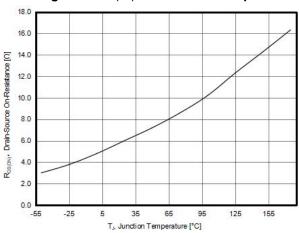


Figure 4. BV<sub>DSS</sub> vs Junction Temperature

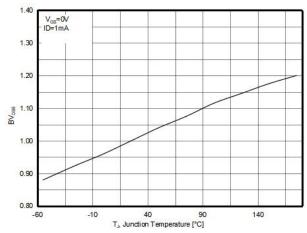


Figure 5. Maximum ID vs Junction Temperature

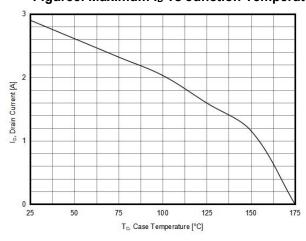


Figure 6. Output characteristics

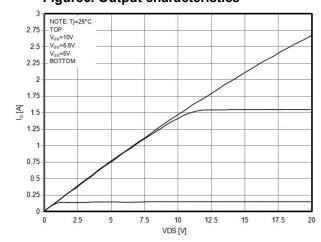
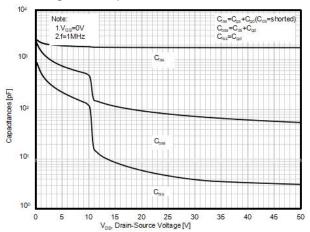




Figure 7. Capacitance



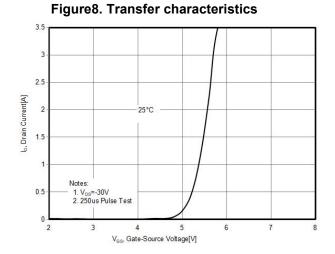


Figure9. Static drain-source on resistance

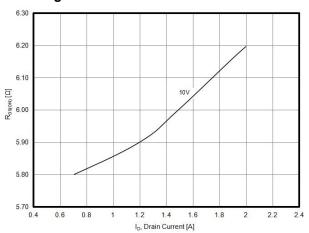
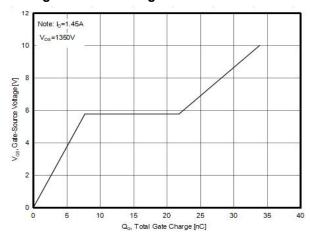


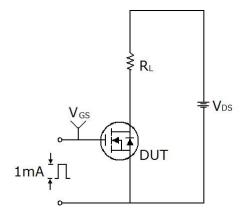
Figure 9. Gate charge waveforms

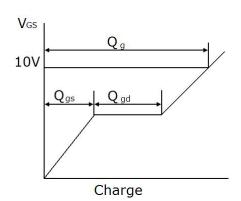




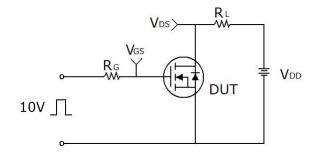
## **Test circuit**

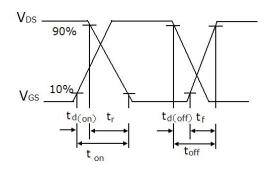
#### 1) Gate charge test circuit & Waveform



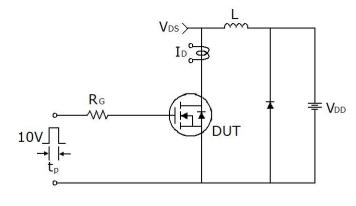


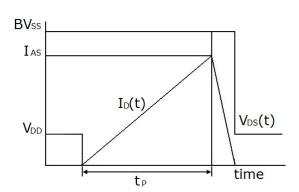
## 2) Switch Time Test Circuit:





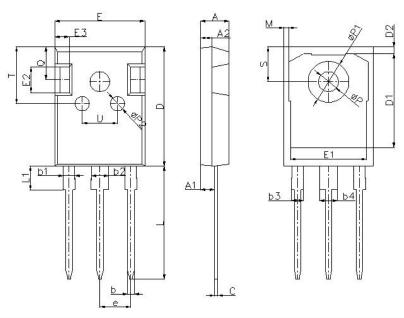
## 3) Unclamped Inductive Switching Test Circuit & Waveforms







# **TO-247-E Package Information**



0	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	4.90	5.10 0.193		0.201	
A1	2.31	2.51	0.091	0.099	
A2	1.90	2.10	0.075	0.083	
b	1.16	1.26	0.046	0.050	
b1	1.96	2.06	0.077	0.081	
b2	2.96	3.06	0.117	0.120	
b3	-	2.25	-	0.089	
b4	-	3.25	-	0.128	
С	0.59	0.66	0.023	0.026	
D	20.90	21.10	0.823	0.831	
D1	16.25	16.85	0.640	0.663	
D2	1.05	1.35	0.041	0.053	
E	15.70	15.90	0.618	0.626	
E1	13.10	13.50	0.516	0.531	
E2	4.40	4.60	0.173	0.181	
E3	2.40	2.60	0.094	0.102	
е	5.436	5.436BSC 0.214BSC		SC	
L	19.80	20.10	0.780	0.791	
L1	-	4.30	-	0.169	
М	0.35	0.95 0.014		0.037	
Q	5.60	6.00 0.220		0.236	
S	6.05	6.25	0.238	0.246	
Т	9.80	10.20	0.386	0.402	
U	6.00	6.40	0.236	0.252	



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